

Topics:

- (i) interplay between the geometric and electronic structure of solid surfaces,
 - (ii) physical properties of surfaces: surface energy, surface stress and their relevance for surface morphology
 - (iii) adsorption and desorption energy barriers, chemical reactivity of surfaces -> heterogeneous catalysis

Technological Importance of Surfaces

Solid surfaces are intriguing objects for basic research,

and they are also of high technological utility:

- substrates for homo- or hetero-epitaxial growth of semiconductor thin films used in device technology
- surfaces can act as heterogeneous catalysts, used to induce and steer the desired chemical reactions



The Geometric and the Electronic Structure of Crystal Surfaces

Surface Crystallography

	2D	3D
number of space groups:	17	230
number of point groups:	10	32
number of Bravais lattices:	5	14

2D- crystal system	symbol	lattice parameters	2D Bravais lattice	space group	point groups
oblique	m (mono- clin)	a, b, γ	mp y b	2	1
rectangular	o (ortho- rhom- bic)	a, b $\gamma = 90^{\circ}$	op b_a oc $b \bullet_a$	7	m 2mm
square	t (tetra- gonal)	a = b $\gamma = 90^{\circ}$	tp a a	3	4 (4mm)
hexagonal	h (hexa- gonal)	a = b $\gamma = 120^{\circ}$	hp a a a a a a a a a a a a a a a a a a a	5	3 6 3m 6mm

Bulk Terminated fcc Crystal Surfaces



Surface Atomic Geometry



et di., 1 Hys. Rev. Lett. 00, 13.

Electronic Structure of Surfaces: Shockley States in the Projected Band Structure



The AI(100) Surface State



Figures taken from: M.C. Desjonqueres, D. Spanjaard, "Concepts in Surface Physics", Springer (Berlin, 1993).

Electronic Structure of Semiconductor Surfaces: Dangling Bonds on Si (001)



atom

molecular orbital picture fictitious surface with almost non-interacting dbs after reconstruction and relaxation



Interplay of the Atomic and Electronic Structure of Si(001)



Mechanisms for Lowering the Surface Energy

reduce density of dangling bonds
 -> by dimerization (Si(100), ~1 eV/db)
 -> ad-atoms (Si(111), rebonded steps on Si(100) vicinals)

formation of π bonds between dangling bonds
 -> Pandey's model of Si(111) (2x1)

Jahn-Teller-like distortions: relaxation and re-hybridization
 -> dimer buckling on Si(100)

• minimization of elastic strain

unusual atomic configurations
 -> subsurface interstitial on Si(113)

and other mechanisms (e.g. for compound semiconductors)



Material Properties of Crystal Surfaces:

Surface Energy

Surface Stress Tensor



Surface Stress Tensor

Definition: surface stress = linear coefficient σ describing the change of surface energy with an applied strain ϵ :

$$\Delta E_{\text{surf}} = \int_{A} \sum_{i,j=1,2} \sigma_{ij} \varepsilon_{ij} \quad d^2 \mathbf{x}$$

$$\rightarrow \Delta E_{\text{Vol}} \sim \epsilon^2$$

 $(\sigma_{xx} > 0 \text{ tensile:} \epsilon_{xx} < 0 \Rightarrow \Delta E_{surf} < 0$, preference for contraction, $\sigma_{xx} < 0 \text{ compressive:} \epsilon_{xx} > 0 \Rightarrow \Delta E_{surf} < 0$, preference for expansion)

Relation to surface energy:

$$\sigma_{ij} = \gamma \delta_{ij} + \frac{\partial \gamma}{\partial \varepsilon_{ij}}$$

(different from liquids!)

Application:

Force density on a surface:

$$\mathbf{f}(\mathbf{x}) = \operatorname{div} \, \sigma(\mathbf{x})$$

Consequence: forces acting at stress domain boundaries -> elastic relaxation -> structure formation on mesoscopic length scales.

Surface Stress Anisotropy: Si(100)

Measurement of surface stress anisotropy: strain surface (by bending the wafer) and determine the relative area of (1x2) and (2x1) dimerized terraces.







F.K. Men, W.E. Packard, M.B. Webb, Phys. Rev. Lett. 61, 2469 (1988). O.L. Alerhand, D. Vanderbilt, R.D. Meade, J.D. Joannopoulos, Phys. Rev. Lett. 61, 1973 (1988).

tunneling microscope image, single atomic-height steps miscut angle $\Theta = 0.3^{\circ}$ (S_A step separation ~ 500 Å) From Swartzentruber et al., Phys. Rev. Lett. 65, 1913 (1990).

Influence of the Reconstruction on Surface Stress Anisotropy

Stress anisotropy calculated from total energy differences: $\Delta E_{surf} = \int_{A} \sum_{i,j=1,2} \sigma_{ij} \varepsilon_{ij} d^{2}\mathbf{x}$

reconstruction	$\sigma^s_{\parallel} - \sigma^s_{\perp}$	$\sigma^b_{\parallel} - \sigma^b_{\perp}$	$\sigma^b_\parallel - \sigma^s_\parallel$	$\sigma^b_\perp - \sigma^s_\perp$
SW (1x2) (Poon et al.)	77 meV/Å 2	-	-	-
DFT-LDA (1x2)	150 meV/Å 2	105 meV/Å 2	30 meV/Å 2	75 meV/Å 2
DFT-LDA p(2x2)	150 meV/Å 2	55 meV/Å 2	30 meV/Å 2	125 meV/Å 2
expt. (Webb et al.)	-	60 – 80 meV/Å 2	-	-



J. Dabrowski, E. P., M. Scheffler, Phys. Rev. B 49, 4790 (1994).
T.W. Poon, S. Yip, P.S. Ho, F.F. Abraham, Phys. Rev. B 45, 3521 (1992).
M.B. Webb, F.K. Men, B.S. Swartzentruber, R. Kariotis, M.G. Lagally, Surf. Sci. 242, 23 (1991).

Calculation of Surface Stress from Total-Energy Differences: The "Reference Surface" Si(111) (1x1) - H





Chemisorption on Semiconductor Surfaces

Model System:

Dissociative Adsorption and Recombinative Desorption of Hydrogen Molecules on/from a Si(100) Surface

Surface Reactivity and Heterogeneous Catalysis

The rate of chemical reactions depends on the reaction energy-barriers along the reaction path:



Dissociative adsorption and recombinative desorption of molecules on a solid surface are an essential step of heterogeneous catalysis:



Dissociative Adsorption of a Molecule on a Solid Surface



hydrogen molecule / H-precovered Si(100)(2x2)



potential energy along the reaction path electronic mechanism of bond formation and breaking



0.5

0

-0.5

z [Å]



It is essential to include the "mechanical" surface degree of freedom in the adsorption/desorption dynamics.

W. Brenig, A. Groß, R. Russ (see e.g. Phys. Rev. B 54, 5978 (1996)).

DFT for Chemisorption: Reaction Path, PES, ...

- chemisorption geometries and energies (equilibrium geometries, reaction energy)
- locate transition state (automated search for special saddle points in the potential energy surface)
- adsorption and desorption energy barrier
- reaction path

(steepest descent from transition state)

• PES, vibrational frequencies

P. Kratzer, B. Hammer, J.K. Norskov, Phys. Rev. B 51, 13432 (1995).

• strain energy of substrate at the transition geometry, etc. ("computer experiments")



- analyse electronic structure (learn about bond breaking and forming mechanism)
- molecular dynamics, quantum-mech. sticking calc. (high-dimensional PES!)
 A. Groß, Surf. Sci. Rep. 32, 291 (1998).



- Reaction path without adsorption energy-barrier for H4 site.
- Comparative study of adsorption sites with fewer pre-adsobed H atoms: Existence of small adsorption energy barriers for H3 and H2 sites (inter-dimer paths).

Things to Keep in Mind ...

E. Penev, P. Kratzer, M. Scheffler, J. Chem. Phys. 110, 3986 (1999).

J.A. Steckel, T. Phung, K.D. Jordan, P. Nachtigall, J. Phys. Chem. B 105, 4031 (2001).

(1) Cluster size convergence:

Si clusters with >= 3 surface dimers should be used.

(2) Semi-local approximation to XC functional (PW91) is not sufficiently accurate for H 2/Si reaction barriers.

Current QMC calculations by S. Healy, C. Filippi for the inter-dimer TS (with PW91 geometries): 2. QMC: E(rxn) ~ 2.4 eV, E(TS) ~ 3.0 eV, E(ads) ~ 0.6 eV PW91: E(rxn) = 1.95 eV, E(TS) = 2.15 eV, E(ads) = 0.2 eV

PW91 calculations are nevertheless usefull to compare between various reaction paths!



(3) Correct reaction energies and barriers for zero-point vibrations.

E.g., decrease reaction energy by 0.2 eV (Steckel et al.).

(4) Be aware of different reaction paths.

Different reaction paths for dissociative adsorption of hydrogen molecules on Si surfaces. Reaction barriers influenced by electronic and geometric effects! Dramatic increase of reactivity at steps and on partially H-precovered surfaces.